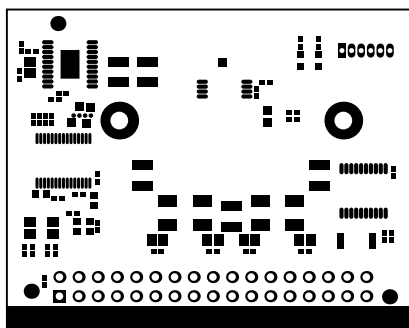
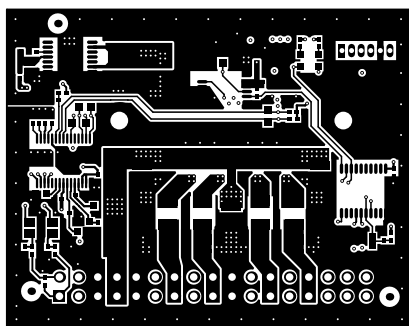


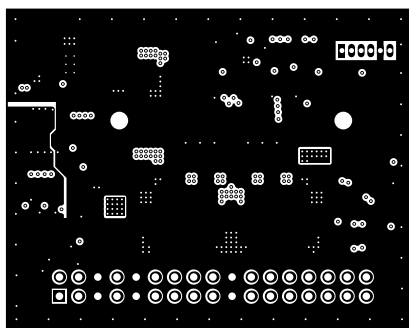
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00743		
PLOT NAME = Top Overlay	GENERATED : 7/17/2017	12:32:19 PM	TEXAS INSTRUMENTS



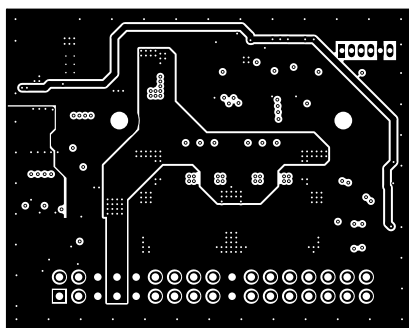
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00743		
PLOT NAME = Top Solder Mask	GENERATED : 7/17/2017 12:32:19 PM	TEXAS INSTRUMENTS	



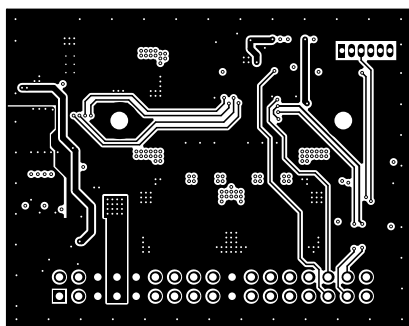
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer	TID #: TIDA-00743		
PLOT NAME = Top Layer	GENERATED : 7/17/2017 12:32:19 PM		TEXAS INSTRUMENTS



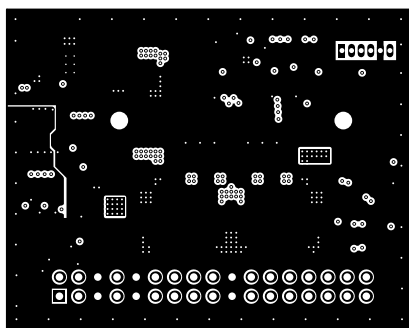
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Layer 2 - GND	TID #: TIDA-00743		
PLOT NAME = Signal Layer 1	GENERATED : 7/17/2017 12:32:19 PM	TEXAS INSTRUMENTS	



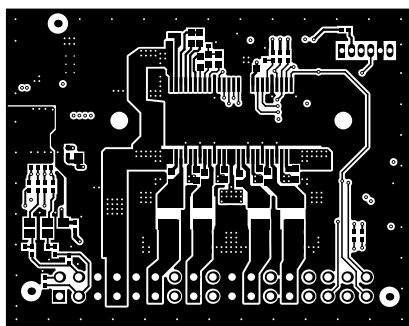
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 - PWR	TID #: TIDA-00743		
PLOT NAME = Signal Layer 2	GENERATED : 7/17/2017 12:32:19 PM	TEXAS INSTRUMENTS	



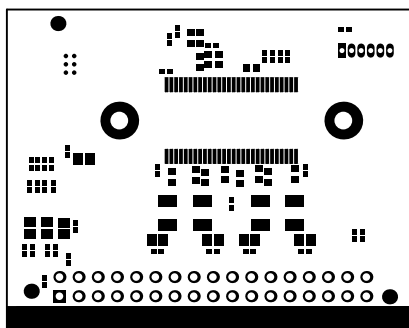
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Layer 3 - Sensitive	TID #: TIDA-00743		
PLOT NAME = Signal Layer 3	GENERATED : 7/17/2017 12:32:19 PM	TEXAS INSTRUMENTS	



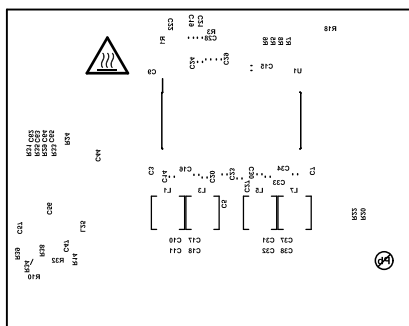
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Layer 5 - GND	TID #: TIDA-00743		
PLOT NAME = Signal Layer 4	GENERATED : 7/17/2017 12:32:19 PM	TEXAS INSTRUMENTS	



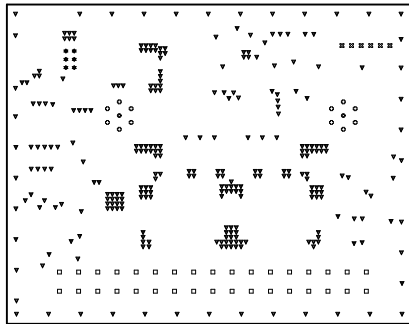
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Layer 6 - Bottom Layer	TID #: TIDA-00743		
PLOT NAME = Bottom Layer	GENERATED : 7/17/2017 12:32:19 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00743		
PLOT NAME = Bottom Solder Mask	GENERATED : 7/17/2017 12:32:19 PM	TEXAS INSTRUMENTS	

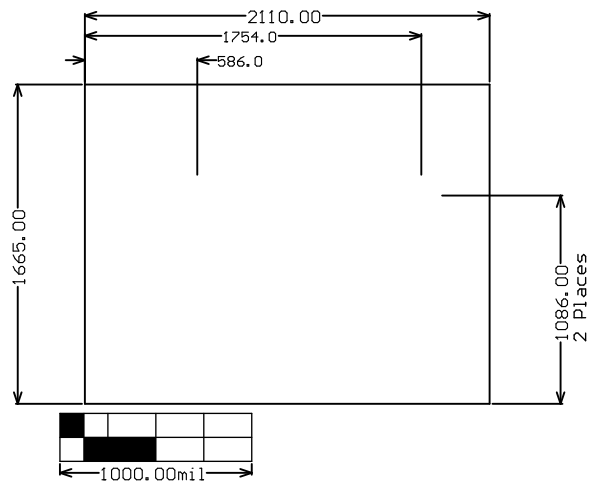


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00743		
PLOT NAME = Bottom Overlay	GENERATED : 7/17/2017 12:32:19 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
✳	6	7.87mil (0.200mm)	PTH	Round
▼	291	10.00mil (0.254mm)	PTH	Round
⊗	12	19.69mil (0.500mm)	PTH	Round
⊗	6	26.00mil (0.660mm)	PTH	Round
□	34	39.37mil (1.000mm)	PTH	Round
⊙	2	92.52mil (2.350mm)	PTH	Round
	351 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00743		
PLOT NAME = Drill Drawing	GENERATED : 7/17/2017 12:32:19 PM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA00743	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00743		
PLOT NAME = Board Dimensions	GENERATED : 7/17/2017 12:32:20 PM	TEXAS INSTRUMENTS	

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